REPLY UNDER 37 CFR 1.116 EXPEDITED PROCEDURE TECHNOLOGY CENTER 2800

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of: Angyal *et al.* **Conf. No.**: 4705

Serial No.: 10/710,706 **Art Unit**: 2813

Filed: 07/29/2004 **Docket No.:** FIS920040028US1 (IBMF-0053)

Examiner: Monica D. Harrison

Title: INTERLEVEL DIELECTRIC

LAYER AND METAL LAYER

SEALING

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

AFTER FINAL REQUEST FOR RECONSIDERATION

Sir:

INTRODUCTORY COMMENTS

In response to the Final Office Action of February 22, 2006, please re-consider the rejections based on the following remarks.